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# Automotive High Speed Communication Technologies

SerDes and Ethernet for Sensor  
and Display Applications



HANSER



Matheus/Kaindl

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SerDes and Ethernet for Sensor and Display Applications

**HANSER**

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# Preface

It is common knowledge that the amount of electronics and software in cars is continuously increasing. Not only are more and more mechanical functions replaced by electronics, but also more driving related functions typically performed by the drivers are substituted or supported by electronic systems, making room for more elaborate and connected infotainment offerings at the same time.

From our perspective, one of the most important enabling infrastructure elements for all of this is the right set of powerful and robust, automotive suitable communication technologies, for which we are at the source. We, the authors of this book, both work at the central department within BMW that is responsible for the in-vehicle communication technologies.

The responsibilities of our department thereby entail it all: the early anticipation and identification of communication requirements, the development and standardization of suitable technologies, the validation and qualification of respective semiconductor products, the writing of requirement specifications on how to deploy the technologies in Electronic Control Units (ECUs) and within the Electric and Electronic (EE) architecture of the cars, ensuring that there are tools and test specifications available, problem solving in case of unexpected errors in the field, and more.

All major car manufacturers have similar departments with a similar set of tasks. Some car manufacturers, like BMW, get involved early. Others might get involved later. What they all have in common is the responsibility for the networking technologies that are used for the communication between many different ECUs, such as LIN, CAN, FlexRay (if used), and lately Automotive Ethernet (especially 100 Mbps). The result is a broad, public knowledge base for all these technologies in the industry and various standardization groups maintaining and advancing the knowhow.

For very application specific technologies, for communication links that are not part of the network (often called “private” communication links), or for communication functions bought in closed systems from Tier 1 suppliers, the situation is not quite as straightforward. These technologies are often not handled in the central departments but within the groups responsible for the application. For these technologies there is little (and practically no public) information available in form of technical descriptions and enabling specifications (EMC, channel, system functions, tests, ...). Industry consortia, driving the technologies forward with consolidated interests, are rare.

The high-speed communication technologies for connecting cameras and displays used to be such application specific technologies. Often seen as private Point-to-Point (P2P) links

with limited numbers per car that are/were supplied in closed systems using proprietary (if not analogue) communication technologies, there has been little incentive for communal efforts in the industry; up to now.

We see various reasons, why it is high time to take responsibility and to broaden the knowledge base in the industry.

1. The number of cameras and displays inside cars is increasing, as is the number of communication links connecting them.
2. The importance and safety criticality of the camera and display applications is increasing. Reliability requirements are higher for a camera image used for an autonomous driving function than for one used during a low-speed parking maneuver. Digital instrument cluster or wing mirror replacement displays are more safety critical than a display showing comparably slow changing map data.
3. The increasing data rates for camera and display links mean increased technical challenges in form of lower Signal-to-Noise-Ratio (SNR) margins and higher sensitivity to link impairments. This requires more specific knowledge on how to make it work. Additionally, not only cameras and displays are aiming for higher resolutions. Higher data rates are also in discussion for various types of sensors.
4. Responsibilities are shifting. Car manufacturers are starting to buy cameras and displays from different Tier 1 suppliers. With that, the systems are no longer closed and the responsibility for the communication technology moves from the Tier 1s to the car manufacturers.
5. EE-architectures are changing. Car manufacturers are exploring zonal architectures, which of now, exclude camera and display data transmission for the lack of sufficient data rates supported by suitable communication technologies. New technical developments for Automotive SerDes and Ethernet allow for architecture options with fewer restrictions.
6. The boundaries between Automotive SerDes and Automotive Ethernet are blurring. For future architectures, both technologies support enough data rate. With the right IC product designs, future SerDes can integrate into an Ethernet network and Ethernet can address camera and display applications. How to efficiently explore this, when both technologies are handled in different departments?
7. Automotive SerDes is being standardized and now actually provides an official framework for the respective work in the industry.

These are good reasons, why some car manufacturers have already moved the responsibility for the camera and display links to the central in-vehicle communication technologies departments. In our case, for example, some of the responsibility for SerDes was moved to us, the authors of this book, as early as 2015. Since then, we have investigated, learned, driven, collected, and are now eager to share. This book is the result. It keeps it technical. We intend this book to support beginners as well as experts at all stages of the value chain in gaining a comprehensive overview on the High-Speed (HS) sensor and display communication technologies Automotive SerDes and HS Automotive Ethernet. We believe in sound technical reasoning and would like to support all interested parties in drawing their own conclusions.



This is the first edition of a new book with lots of new content. It would not have been possible to complete it in the same quality without the many colleagues who answered all the smaller or larger questions we had. We would like to thank (in alphabetical order) Heather Babcock (TI), Kristian Baumann (BMW), Bert Bergner (TE), Andreas Brösse (BMW), Vijay Ceekala (TI), Jim Conder (Socionext), Kamal Dalmia (Aviva Links), Mario Heid (Omnivision), Stefan Holz knecht (BMW), Kilian Jacob (BMW), Ariel Lasry (Qualcomm), Balagopal Mayampurath (ADI), Andy McLean (ADI), Chanakya Metha (TI), Thorsten Meyer (Valeo), Roland Neumann (Inova), Takashi Nishimura (SONY), Jochen Schyma (NXP), Anton Sifferlinger (BMW), Luisma Torres (KDPOF), Dirk Waldhauser (BMW), Rick Wietfeldt (Qualcomm), Conrad Zerna (Aviva Links), and George Zimmerman (CME Consulting).

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June 2022, *Michael Kaindl* and *Kirsten Matheus*

# Timeline

- 1886 Carl Benz is granted a patent on “Fahrzeug mit Gasmotorenbetrieb (engl.: gas powered vehicle)” [1] and starts building identical copies of cars. While several motor vehicles have been built prior to this and successful commercial exploitation still needs some years to come [2], 1886 can be seen as the starting year for commercial automobile production. Tachometers had been invented in 1817 and were first used in trains in 1840. It is unclear when they were first used in cars [3].
- 1892 First ever law on ElectroMagnetic Compatibility (EMC) is passed in Germany in the context of the upcoming telegraph and telephone business [4].
- 1902 German engineer Otto Schulze patents a technology using a magnet created eddy-current that translates the speed of rotation of the wheels to a dial. Until well into the 1980s, almost all speedometers in cars were based on this technology. Speedometers are standard equipment in cars by 1910 [5].
- 1904 First patent on radar technology is filed at the German patent office for “a method to notify of the presence of metallic objects with help of electromagnetic waves” which can determine the objects distance [6].
- 1908 The first car produced in a moving assembly line is the Ford Model T [7].
- 1917 Invention of the fuel gauge [8].
- 1927 Germany passes the first law on the use and installation of high frequency radio transmitters, which, with adaptations, is in place until 1995 [4].
- 1930 Sale start of first commercially successful in-car radio [9].
- 1931 The Commission Internationale de l'Éclairage (CIE) defines with the Red Green Blue (RGB) color space the first quantitative relationship between the distribution of wavelengths in the visible spectrum and perceived colors [10].
- 1933 Founding of the Comité International Spécial des Perturbations Radioélectriques (CISPR) in order to develop guidelines on EMC in Europe [4].
- 1952 First sale of commercial Frequency Modulation (FM) in-car radios. Amplitude Modulation (AM) is dominantly used in the market at the time [9].

- 1956 Advent of the first fully automated mobile telephone system, allowing making and receiving calls in cars using the public telephone network [11].
- 1956 Jan. First showcase of a backup camera is presented at the General Motors Motorama in a Buick Centurion concept car [12].
- 1958 Dec. Publication on laser marks its invention [13].
- 1973 Year of the invention of Ethernet. Ethernet is demonstrated for the first time at Xerox PARC in order to enable the transmission of data between Xerox's personal computer workstations and laser printers [14] [15].
- 1973 The International Electrotechnical Commission (IEC) creates a special technical committee to specify EMC for different fields of use [4].
- 1974 First Charge-Coupled Device (CCD) image sensor goes into production [16].
- 1974 Dec. First release of the "Specification of Internet Transmission Control Protocol (TCP)" [17].
- 1976 Sep. 9 The president of JVC presents the Video Home System (VHS) [18]. Other markets outside Japan receive the first products from 1977 on [19].
- 1979 Aston Martin presents its Lagonda with an elaborate array of LED screens [20].
- 1979 Jun. The 7-layer Open Systems Interconnection (OSI) model is published at the International Organization for Standardization (ISO) [21]. The respective committee was formed in 1977 [22].
- 1980 Dec. The Institute of Electrical and Electronics Engineers (IEEE) starts the 802.3 working group dedicated to CSMA/CD (Ethernet) [23].
- 1981 Release of the first commercially available in-car navigation system by Honda called "Electro Gyro-Cator" that provided guidance by tracking the distance and direction travelled from the start point [24].
- 1982 Philips Semiconductors (now NXP Semiconductors) develops the Inter-IC bus (I2C) [25].
- 1982 Jan. 26 As the first car manufacturer, Toyota offers a sonar-based backup parking system in a series production car [26].
- 1982 Oct. First commercial CD-player is sold in Japan (by Sony) [27].
- 1983 Introduction of the analogue content protection technology from Macrovision for VHS video cassettes [28].
- 1985 First factory-installed in-car CD player [9].
- 1986 Kodak develops the first digital camera to record 1.4 MPixels. It uses a CCD imager [29].
- 1986 The Buick Riviera is likely the first series production car with a touch screen [20].
- 1986 Feb. First release of the Philips Semiconductors' (now NXP Semiconductors') I2S audio bus interface specification [30].

- 1987 Toyota sells its Royal Crown model with a color display for its CD-based navigation system [20].
- 1988 Establishment of the Moving Picture Experts Group (MPEG) for the development of standards for the coded representation of media data such as audio and video [31].
- 1988 Nov. The Video Electronics Standards Association (today only using its abbreviation “VESA”) is founded on the initiative of NEC in order to standardize video display interfaces [32]. The organization is incorporated in July 1989 [33].
- 1989 Oct. The TCP/IP Internet Protocol Suite is being published as “Requirements for Internet Hosts – Communication Layers”, RFC 1122 [34] and “Requirements for Internet Hosts – Application and Support”, RFC 1123 [35].
- 1989/90 The World Wide Web (www) is invented at CERN [36].
- 1990 Development of the CMOS active pixel sensor [37].
- 1990 Mazda introduces its Eunos Cosmo with an in-dashboard color display as the first GPS-based navigation system [20].
- 1990 Sep. IEEE 802.3 ratifies the Ethernet specification 10BASE-T [15], with which Ethernet allegedly won the battle over competing technologies [14].
- 1992 The first “smart” mobile phone with a touch screen, the IBM Simon, is commercially sold [38].
- 1992 Sep. 18 The International Telecommunication Union (ITU) releases the Recommendation T.81 for the Joint Photographic Expert Group (JPEG) compression format [39].
- 1994 Jun. First release of the AEC-Q100 specification on automotive quality for integrated circuits at the Automotive Electronic Council (AEC) [40].
- 1994 National Semiconductor (now TI) introduces the Low Voltage Differential Signaling (LVDS) technology [41], which is subsequently published as ANSI/TIA/EIA-644-1995 [42] and as IEEE 1596.3 in July 1996 [43]. The data rate the standard originally supports is 655 Mbps.
- 1995 The ISO/IEC publishes a backwards compatible MPEG-2 Audio specification (MPEG-2 Part 3) – commonly referred to as MP3 – with additional bit and sample rates [44].
- 1995 Dec. 8 Toshiba, Matsushita, Sony, Philips, Time Warner, Pioneer, JVC, Hitachi, and Mitsubishi Electric announce their agreement on a unified DVD format [45].
- 1996 The ISO/IEC publishes the MPEG-2 video (MPEG-2 Part 2) specification, which is used among other, for the DVD standard. The ITU publishes it as H.262 [46].
- 1996 National Semiconductor (now TI) develops the first FPD-link specification, which it publishes in order to achieve a large market acceptance [47].

- 1996 Nov. 5 Hewlett-Packard and Microsoft propose the standard RGB (sRGB) color space for monitors, printers, and the www [48]. In 1999, the IEC published it as IEC 61966-2-1:1999 [49].
- 1997 Publication of IEEE 802.3x, which supports full-duplex operation for Ethernet [50].
- 1998 First Publication of IEEE 802.1Q, which adds – among other functions – the option of eight priority queues and Virtual LANs (VLANs) to Ethernet communication [51].
- 1998 Daimler introduces the first radar based adaptive speed driver assist system into the market [52].
- 1998 Oct. 28 U.S. president Bill Clinton signs the Digital Millennium Copyright Act (DMCA), which provides the basis for the prosecution of copyright infringements on the Internet. It is subsequently adopted similarly in other countries and regions [53].
- 1999 May Napster launches its “share it with all for free” platform. This is possible because of the combination of Internet and audio compression standards. It irreversibly changed the media industry and media consumption. It lasted until February 2001 [54].
- 1999 May The first phone with an integrated camera, the Kyocera VP-210, is commercially sold to the general public [55].
- 1999 Apr. 2 Release of the Digital Visual Interface (DVI) by the Digital Display Working Group (DDWG), which focusses on providing a standardized connection between a computer and a displaying device [56].
- 1999 May 13 National Semiconductor (now TI) releases the Open LVDS Display Interface (OpenLDI) Specification v. 0.95 as an open standard to complete the digital connection between video sources and displaying devices [57] as initiated with the LVDS technology.
- 2000 The Nissan Infinity Q45 is offering a series production rear view/backup camera. This is said to have initiated the backup camera market [12].
- 2000 Feb. 17 Intel releases version 1.0 of the High-bandwidth Digital Content Protection (HDCP) specification, which targets at preventing the recording and distribution of HD video content [58]. In the coming years, its support is mandated by many content providers.
- 2001 Nov. Start of Production (SOP) of the BMW 7 series using a central, dashboard-mounted display for user information and interaction (plus “iDrive”) [59]. Often, credit is given to BMW for initiating that such a screen as a central hub for car interaction has become a standard feature [60]. The same car is also the first with a digital video link to connect a display: The FPD-link is used for connecting the Rear Seat Entertainment (RSE) display.
- 2002 Dec. 9 Announcement of the HDMI 1.0 connectivity standard by the seven founding members Hitachi, Matsushita, Philips, Silicon Image, Sony, Thomson, and Toshiba [61] (now Lattice, Maxell, Panasonic, Philips, Sony, Technicolor, and Toshiba [62]).

- 2003 First publication of ISO/IEC 14496-10, also known as MPEG-4 Advanced Video Codec (AVC) or ITU H.264 [63].
- 2003 Jul. ARM, Nokia, STMicroelectronics, and Texas Instruments (TI) found the Mobile Industry Processor Interface (today only using its abbreviation “MIPI”) Alliance to define standards for cell phones that at the same time reduce complexity and costs while allowing flexibility [64].
- 2003 Aug. 4 As the first region in Germany, Berlin ends its analogue terrestrial TV broadcast in favor of digital broadcast with Digital Video Broadcasting Terrestrial (DVB-T) [65]. This is an exemplary date for a worldwide transition. By 2017, worldwide digital terrestrial TV broadcast was split over four major technologies: DVB-T2, Integrated Services Digital Broadcasting (ISDB), Advanced Television Systems Committee (ATSC), or Digital Terrestrial Media Broadcast (DTMB) [66].
- 2004 Jul. IEEE kicks off the development of standards that allow adding Quality of Service (QoS) functions to Ethernet [67]. This is first called Audio Video Bridging (AVB), shifted to IEEE 802.1 in 2005 [68], and, in 2012, renamed Time Sensitive Networking (TSN) [69].
- 2005 First release of the MIPI CSI-2 and DSI-2 specifications [70] [71].
- 2006 May Publication of the first VESA DisplayPort specification v1.0 [72] [73]. The first embedded Display Port (eDP) specification is published in December 2008 [74].
- 2007 Nissan introduces the first surround view camera system with its Infiniti EX35 [75].
- 2008 Oct. SOP of the first series production car deploying Ethernet as a communication technology. The BMW 7 series uses 100BASE-TX Ethernet as a diagnostic interface with Unshielded Twisted Pair (UTP) cabling and for the communication between HeadUnit (HU) and Rear Seat Entertainment (RSE) with Shielded Twisted Pair (STP) cabling [76].
- 2010 IEEE 802.3 releases the 802.3az specification on Energy Efficient Ethernet (EEE) [50]. This is an important step to saving energy in a switched Ethernet system. Much later, applied separately to each communication direction, it is especially useful in case of highly asymmetric communication.
- 2011 Oct. The HDMI founders create the HDMI Forum in order to allow all interested companies to be an integral part of the development process [77].
- 2013 Sep. SOP of the first series production car deploying “Automotive Ethernet”. The BMW X5 uses BroadR-Reach with single UTP for connecting the cameras to the surround view system [76]. The technology is ratified by the IEEE as IEEE 802.3bw/100BASE-T1 Ethernet on October 26, 2015 [78].
- 2014 Sep. 30 Publication date of the ISO 17215 specification series “Road Vehicles – Video Communication Interface for Cameras (VCIC)” defining Ethernet as the communication interface [79].

- 2015 Dec. 12 The so-called Paris Agreement is adopted by the United Nations Framework Convention on Climate Change (UNFCCC). Its goal to limit the global warming to below 2 °C (ideally to 1.5 °C) above preindustrial level [80] leads to stringent CO<sub>2</sub> targets for the car industry.
- 2016 Nov. 10 Call For Interest (CFI) is presented and approved that initiates the efforts to standardize what later becomes MultiGBASE-T1 Ethernet for 2.5, 5, and 10 Gbps data rate in automotive environments at IEEE 802.3 [81].
- 2016 Dec. IEEE 802.3 releases the IEEE 802.3bu specification on Power over Data Line (PoDL) [50]. While this specification targets the single pair 100 Mbps and 1 Gbps Automotive Ethernet technologies, it set an important starting point for higher data rates.
- 2017 Jan. The MIPI Alliance concludes its I3C specification v1.0. A public version is released in December of the same year [82].
- 2018 The Audi A8 is the first series production car with a Lidar [83]. However, after having subsequently removed it [84], the XPeng P5 might have rightly claimed to be once more the first in December 2021 [85].
- 2018 Aug. 2 The MIPI Alliance announces the standardization of their A-PHY [86].
- 2019 May Founding of the Automotive SerDes Alliance (ASA) [87].
- 2019 July CFI for an automotive suitable multi-Gbps optical Ethernet PHY technology is presented and accepted at IEEE 802.3 [88].
- 2020 Jun IEEE 802.3 releases the IEEE 802.3ch/MultiGBASE-T1 specification for 2.5, 5, and 10 Gbps transmission over a single twisted pair in an automotive environment [50]. While the specification allows for symmetric data rates only, the EEE function may be activated individually per direction.
- 2020 Jun. 24 The “Greater than 10 Gb/s Electrical Automotive Ethernet PHYs Task Force (TF)” holds its first meeting at IEEE 802.3 [89]. Being able to use the technology asymmetrically is one of the properties discussed but adhered to only by applying EEE asymmetrically.
- 2020 Jul. 14 The Multi-Gigabit Optical Automotive Ethernet TF holds its first TF meeting at IEEE 802.3 [90].
- 2020 Sep. 15 MIPI announces the release of their MIPI A-PHY specification 1.0 [91].
- 2020 Oct. 13 The Automotive SerDes Alliance announces the finalization of their ASA Motion Link specification 1.01 [87].

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# Abbreviations and Glossary

|  | Abbreviation | Explanation   |  |
|--|--------------|---|--|
|  | 1PPODL       | One Pair Power Over Data Line                               | Study group name for IEEE 802.3bu  |
|  | 2D           | 2-Dimensional   |  |
|  | 3D           | 3-Dimensional   |  |
|  | 4PPoE        | Four Pair Power over Ethernet                               | IEEE 802.3bt 2018, for cables consisting of four twisted pairs                                     |
|  | 8P8C         | 8 Positions 8 Contacts                                      | Modular connector specified in IEC 60603-7   |
|  | μ            | micro   |  |
|  | μC           | MicroController   |  |
|  | A            | Ampere  |  |
|  | A2B          | Automotive Audio Bus  | Communication interface from ADI   |
|  | AC           | Alternating Current   |  |
|  | ACC          | Adaptive Cruise Control                                     |  |
|  | ACK          | ACKnowledge   |  |
|  | ACMD         | A-PHY Control and Management Database                       |  |
|  | ACMP         | A-PHY Control and Management Protocol                       |  |
|  | AD           | Autonomous Driving  |  |
|  | ADAS         | Advanced Driver ASsist or Advanced Driver Assistance System |  |
|  | ADC          | Analogue to Digital Converter or Conversion                 |  |
|  | ADI          | Analog Devices  |  |
|  | AEB          | Automated Emergency Braking                                 |  |
|  | AEC          | Automotive Electronic Council                               | Standardization organization focusing on electronic part qualification for the automotive industry |
|  | AFDX         | Avionics Full-Duplex Switched Ethernet                      | Ethernet protocol used in the aerospace industry   |

|               | Abbreviation                              | Explanation   |
|---------------|---|---|
| AGC           | Adaptive Gain Control                     |   |
| AIAG          | Automotive Industry Action Group          |   |
| ALEI          | Adaptation Layer Extended Information     | Part of the IEEE 2977 DLL packet  |
| ALSE          | Absorber-Lined Shielded Enclosure         | Described in ISO 11452-2  |
| AM            | Amplitude Modulation                      | Used for the reception of analogue radio in the short, medium and long wave bands |
| AMEC          | Automatable Module Ethernet Connector     |   |
| AML           | ASA Motion Link                           | Also ASAML  |
| AMP           | Amplifier                                 |   |
| ANSI          | American National Standards Institute     | US SSO based in Washington D. C.  |
| AOSC          | Always-On Sentinel Conduit                | Part of CSI-2 v4.0  |
| APD           | Avalanche Photo Diode                     |   |
| API           | Application Programming Interface         |   |
| APIX          | Automotive PIXel link                     | Inova's name for their proprietary SerDes technology                              |
| APPI          | A-PHY Protocol Interface                  |   |
| ARQ           | Automatic Retransmission/Repeat reQuest   |   |
| ASA           | Automotive SerDes Alliance                | Alliance for Automotive SerDes connectivity, home of the ASA Motion Link          |
| ASAML         | ASA Motion Link                           | Also AML  |
| ASE           | Application Stream Encapsulator           | Part of the ASAML   |
| ASEP          | Application Stream Encapsulation Protocol | Protocol adaptation for the ASA Motion Link                                       |
| A-shell       | Automotive shell                          | Unified communication interface for the side-channel of APIX                      |
| ASIC          | Application-Specific Integrated Circuit   |   |
| ASIL          | Automotive Safety Integrity Level         | Classification methodology for functional safety                                  |
| ASP           | Abstract Service Primitive                |   |
| ATCA          | Advanced TeleComputing Architecture       | I2C derivate  |
| ATS           | Asynchronous Traffic Shaping              | Defined in IEEE 802.1Qcr-2020   |
| ATSC          | Advanced Television Systems Committee     | US American set of digital television standards                                   |
| AUTOSAR       | AUTomotive Open System ARchitecture       |   |
| AUTOSAR SecOC | AUTOSAR SECure Onboard Communication      |   |
| AV            | Audio/Video                               |   |

|         | Abbreviation  | Explanation  |
|---------|---|--|
| AVB     | Audio Video Bridging                                |  |
| AVC     | Advanced Video Coding                               |  |
| AVP     | Autonomous Valet Parking                            |  |
| AWG     | Arbitrary Waveform Generator or American Wire Gauge |  |
| AWGN    | Additive White Gaussian Noise                       |  |
| B2B     | Business-to-Business                                |  |
| BCI     | Bulk Current Injection                              |  |
| BER     | Bit Error Rate                                      |  |
| B-frame | Bi-directional predictive coded picture or frame    | Part of MPEG encoding  |
| BGA     | Ball Grid Array                                     | Package type for semiconductors  |
| BIST    | Built-In Self-Test                                  |  |
| BK      | Binding Key   | Part of the ASA security concept   |
| BMCA    | Best Master Clock Algorithm                         | Part of IEEE 802.1AS-2011  |
| BNC     | Bayonet Neill Concelman                             | Connector used also for CBVS video, named after their inventors          |
| BOM     | Bill of Material                                    |  |
| bpp     | bits per pixel                                      |  |
| bps     | bits per second                                     |  |
| BSD     | Blind Spot Detection                                |  |
| BTA     | Bus TurnAround                                      | Part of MIPI C- and D-PHY  |
| B/W     | Black & White                                       |  |
| CAD     | Command-Address-Data                                | Part of the ASAML OAM  |
| CAN     | Controller Area Network                             |  |
| CAN FD  | CAN Flexible Data rate                              |  |
| CAT     | CATegory  | Used for data center cable standards                                     |
| CBS     | Credit Based Shaper                                 | Used with IEEE 802.1Qav 2009   |
| CCC     | Capacitive Coupling Clamp method                    | For testing resistance to fast transient pulses                          |
| CCD     | Charge-Coupled Device                               | Imager technology  |
| CCS     | Camera Command Set                                  | Part of the MIPI CSI-2 interface building blocks                         |
| CD      | Compact Disc or Collision/Contention Detection      |  |
| CDE     | Cable Discharge Event                               | Type of ESD test   |
| CDM     | Charged Device Model                                | Type of ESD test   |
| CE      | Consumer Electronics                                |  |
| CEC     | Consumer Electronics Control                        | Part of HDMI supporting remote control of HDMI connected display devices |



|                 | Abbreviation  | Explanation  |
|-----------------|---|--|
| CERN            | Conseil Européen pour la Recherche Nucléaire (European Council for Nuclear Research)      |  |
| CFA             | Color Filter Array  |  |
| CFI             | Call For Interest   | Project initiation item at IEEE 802.3  |
| CFS             | Clock Forwarding Service  | Part of IEEE 2977  |
| CiA             | CAN in Automation   | Organization that drives the CAN specification development for the automotive industry   |
| CIA             | Confidentiality, Integrity, and Availability  |  |
| CIE             | Commission Internationale de l'Éclairage (engl. International Commission on Illumination) | International authority on light, illumination, color, and color spaces seated in Vienna |
| CIS             | CMOS Image Sensor   |  |
| CISPR           | Comité International Spécial des Perturbations Radioélectriques                           | Sets standards for EMC in cars, now part of IEC  |
| CLK             | CLock   |  |
| CTL             | ConTroL   |  |
| CTLE            | Continuous-Time Linear Equalizer  |  |
| CMC             | Common Mode Choke   |  |
| CMD             | Command   |  |
| CML             | Current Mode Logic or Channel Monitor Loop  |  |
| CMOS            | Complementary Metal-Oxide Semiconductor   |  |
| CMYK            | Cyan Magenta Yellow black   | Subtractive color format used for printing   |
| CO <sub>2</sub> | Carbon DiOxide  |  |
| con.            | connector   |  |
| CPU             | Central Processing Unit   |  |
| CRC             | Cyclic Redundancy Check   |  |
| CRT             | Cathode-Ray Tube  |  |
| CS              | Chip Select   |  |
| CSE             | Camera Service Extensions   | MIPI protocol  |
| CSI             | Camera Serial Interface   | MIPI protocol  |
| CSMA/CD         | Carrier Sense Multiple Access with Collision Detection                                    |  |
| CTS             | Conformance Test Specifications   | General term but specifically used in MIPI   |
| CuMg            | Copper-Magnesium  |  |
| CuSn            | Copper-Tin  |  |

|                  | Abbreviation                                | Explanation   |
|------------------|---|---|
| CVBS             | Color, Video, Blanking, and Synchronization | Analogue signal for color TV  |
| CW               | Continuous Wave                             |   |
| D <sup>2</sup> B | Domestic Digital Bus                        |   |
| DAC              | Digital to Analogue Converter/Conversion    |   |
| DC               | Direct Current                              |   |
| DCC              | Direct Capacitive Coupling method           | For testing resistance to fast and slow transient pulses  |
| DCP              | Digital Content Protection LLC              | Organization that licenses HDCP   |
| DCS              | Display Command Set                         | MIPI specification  |
| DCT              | Discrete Cosine Transformation              |   |
| DDC              | Display Data Channel                        | VESA specification  |
| DDWG             | Digital Display Working Group               | Organization responsible for DVI  |
| DEC              | Digital Equipment Corporation               |   |
| DES              | DESerializer                                |   |
| DFE              | Decision Feedback Equalizer                 |   |
| DFP              | Digital Flat Panel                          | Early VESA specification  |
| DIN              | Deutsches Institut für Normung              | German SSO based in Berlin  |
| DK               | Device Key                                  | Part of the ASAML security concept  |
| DL               | DownLink                                    | Transmission direction with the higher data rate in an asymmetric communication system. Often synonymously used with DS.  |
| DLL              | Data Link Layer                             | Layer 2 of the ISO/OSI layering model   |
| DM               | Dieselhorst-Martin                          | Type of cable stranding   |
| DMA              | Direct Memory Access                        |   |
| DMCA             | Digital Millennium Copyright Act            |   |
| DoS              | Denial of Service                           | Security attack that floods a node's resources with so much data that it starts denying additional communication requests |
| DP               | DisplayPort                                 | Interface for display connectivity from VESA  |
| DPCP             | DisplayPort Content Protection              |   |
| DPI              | Dots Per Inch or Direct Power Injection     | Like PPI or type of EMC measurement   |
| DS               | DownStream                                  | Transmission direction with the higher data rate in an asymmetric communication system. Often synonymously used with DL.  |
| DSC              | Display Stream Compression                  | Video compression format standardized by VESA   |

|         | Abbreviation                                 | Explanation  |
|---------|--|--|
| DSE     | Display Service Extensions                   | MIPI specification   |
| DSI(-2) | Display Serial Interface                     | Protocol defined by the MIPI Alliance  |
| DSI3    | Distributed Systems Interface 3              | Sensor interface of the DSI consortium   |
| DSNU    | Dark Signal Non-Uniformities                 |  |
| DSP     | Digital Signal Processor                     |  |
| DTLS    | Datagram TLS                                 | UDP variant of TLS   |
| DTMB    | Digital Terrestrial Multimedia Broadcast     | Standard for digital television transmission used in China                     |
| DUT     | Device Under Test                            |  |
| DVB(-T) | Digital Video Broadcasting (for Terrestrial) | Standard for digital television transmission, which originated in Europe       |
| DVD     | Digital Video/Versatile Disc                 |  |
| DVI     | Digital Visual Interface                     |  |
| E       | Electric (field)                             |  |
| ECIA    | Electronic Components Industry Association   | US-based SSO   |
| ECU     | Electronic Control Unit                      | Name for physical units containing electronics inside cars                     |
| EDID    | Extended Display Identification Data         | Display mode information format of VESA used in the DDS                        |
| eDP     | embedded DisplayPort                         | Interface for display connectivity from VESA                                   |
| EE      | Electrics and Electronics                    |  |
| EEE     | Energy Efficient Ethernet                    | Specified in IEEE 802.3az  |
| EFM     | Ethernet in the First Mile                   | Specified in IEEE 802.3ah  |
| EIA     | Electronics Industry Alliance                | US- based SSO dissolved in 2011, now ECIA                                      |
| ELFEXT  | Equal Level Far End CrossTalk                |  |
| EMC     | ElectroMagnetic Compatibility                |  |
| EME     | ElectroMagnetic Emissions                    |  |
| EMI     | ElectroMagnetic Immunity                     | sometimes, not in this book though, also used for ElectroMagnetic Interference |
| ENIS    | End-Node-Interconnect-Structure              | MDI network in the A-PHY specification   |
| EOP     | End Of Production                            |  |
| EPON    | Ethernet Passive Optical Networks            |  |
| EPROM   | Erasable Programmable Read-Only Memory       |  |
| ESD     | ElectroStatic Discharge                      |  |
| ESR     | Equivalent Series Resistance                 | DC resistance of capacitors  |
| ETSC    | European Transport Safety Council            |  |

|          | Abbreviation                           | Explanation   |
|----------|--|---|
| EU       | European Union                         |   |
| EuroNCAP | European New Car Assessment Program    |   |
| F        | Farad                                  | Unit for capacitances   |
| FAKRA    | FACHausschuss KRAftfahrzeuge           | Subgroup in DIN, often synonymously used for a specific coaxial connector               |
| FB       | Ferrite Bead                           |   |
| FBAS     | Farb-Bild-Austast-Synchron-Signal      | German for CVBS signal, colloquially "Farbfernsehsignal"                                |
| FCC      | Federal Communications Commission      | US government agency that regulates, among other, radio frequency use                   |
| FCS      | Frame Check Sequence                   |   |
| FCW      | Forward Collision Warning              |   |
| FDD      | Frequency Division Duplex              | Method to separate two data streams (in the same or opposite directions) on one channel |
| FEC      | Forward Error Correction               |   |
| FEXT     | Far-End CrossTalk                      |   |
| FFE      | Feed Forward Equalizer                 |   |
| FFT      | Fast Fourier Transformation            |   |
| FHD      | Full High Definition                   |   |
| FM       | Frequency Modulation                   | Used for the reception of analogue radio in the ultra short wave band                   |
| FMCW     | Frequency Modulated Continuous Wave    |   |
| FMVSS    | Federal Motor Vehicle Safety Standards |   |
| FoFa     | Forwarding Fabric                      | Part of the ASAML   |
| FOT      | Fiber Optical Transmitter              |   |
| FPD      | Flat Panel Display                     | SerDes technology   |
| fps      | frames per second                      |   |
| FR       | Flame Retardant                        | PCB material type   |
| FRC      | Frame Rate Control                     | Method to emulate a high color resolution on a display than available                   |
| FRR      | Front Range Radar                      | See LRR   |
| FSED     | Frame Service Extension Data           | Part of MIPI CSE and DSE  |
| G        | Gear or Giga                           | Name of different data rate classes for the MIPI A-PHY or 10 <sup>9</sup>               |
| Gbps     | Gigabits per second                    |   |
| GI-POF   | Graded Index POF                       |   |
| GMSL     | Gigabit Multimedia Serial Link         | Trade name for the proprietary SerDes technology of Maxim Integrated (now ADI)          |

|               | Abbreviation                              | Explanation  |
|---------------|---|--|
| GND           | Ground                                    |  |
| GOF           | Glass Optical Fiber                       |  |
| GoP           | Group of Pictures                         | Part of video compression                                |
| GPIO or GPI/O | General Purpose Input/Output              |  |
| Gpps          | GigaPixels Per Second                     |  |
| GPS           | Global Positioning System                 |  |
| gPTP          | Generalized Precision Time Protocol       | Protocol specified in IEEE 802.1AS-2011                  |
| GPU           | Graphics Processing Unit                  |  |
| GUI           | Graphical User Interface                  |  |
| GVIF          | Gigabit Video InterFace                   | Trade name for the proprietary SerDes technology of SONY |
| H             | Henry                                     | Physical unit for magnetic (field) strength              |
| HBM           | Human Body Model                          | Type of ESD test   |
| HBR           | High Bit Rate                             | Data rate class for DP                                   |
| HD            | High Definition                           |  |
| HDCP          | High-bandwidth Digital Content Protection |  |
| HDMI          | High Definition Multimedia Interface      |  |
| HDR           | High Dynamic Range or High(er) Data Rate  | The latter is an I3C terminology                         |
| HDTV          | High-Definition TeleVision                |  |
| HEIF          | High Efficiency Image File format         | New format for digital images                            |
| HEVC          | High Efficiency Video Coding              | Also known as H.265/MPEG-H Part 2                        |
| HF            | High Frequency                            |  |
| HFM           | High-speed FAKRA Mini                     | Connector type for coaxial cables                        |
| HMI           | Human Machine Interface                   |  |
| H-MTD         | High-speed Modular Twisted-pair Data      | Connector type for STP cables                            |
| HQ            | HeadQuarter                               |  |
| Hres          | Horizontal RESolution                     |  |
| HS            | High Speed                                |  |
| HSB           | Hue Saturation Brightness                 | Color format derived from RGB                            |
| HSD           | High-Speed Data                           | Connector type for STQ cables                            |
| HSI           | Hue Saturation Intensity                  | Color format derived from RGB                            |
| HSL           | Hue Saturation Lightness                  | Color format derived from RGB                            |
| HSV           | Hue Saturation Value                      | Color format derived from RGB                            |
| HSVL          | High Speed Video Link                     | Early name for Automotive SerDes                         |
| Hsync         | Horizontal SYNChronization                | Related to horizontal blanking                           |

|              | Abbreviation   | Explanation   |
|--------------|--|---|
| HU           | Head Unit  | Main ECU for infotainment functions inside cars   |
| HW           | HardWare   |   |
| I2C          | Inter-IC, also I <sup>2</sup> C or IIC                   | Serial communication bus invented by Philips in 1982  |
| I2S          | Inter-IC Sound, also I <sup>2</sup> S                    | Audio bus invented by Philips in 1986   |
| I3C          | Improved Inter-IC bus                                    | MIPI protocol   |
| IATF         | International Automotive Task Force                      | Defines an automotive quality management system   |
| IBG          | InterBurst Gap   | Part of the ASAML TDD scheme  |
| IC           | Integrated Circuit                                       |   |
| ICC          | Inductive Coupling Clamp method                          | For testing immunity against slow transients  |
| ICMP         | Internet Control Message Protocol                        |   |
| ICT          | In-Circuit Testing                                       |   |
| ICV          | Integrity Check Value                                    | Essential part of security mechanisms for authentication  |
| IEC          | International Electrotechnical Commission                | SSO situated in Geneva, Switzerland   |
| IEEE         | Institute of Electrical and Electronics Engineers        | “The world’s largest technical professional organization for the advancement of technology (ieee.org)”. Among other, standardizes Ethernet. |
| IET          | Interspersing Express Traffic                            | IEEE 802.3br-2016   |
| IETF         | Internet Engineering Task Force                          | US-based SSO seated in Wilmington, DE   |
| I-frame      | Intra frame or picture                                   | Still image representation of MPEG  |
| IF           | InterFace  |   |
| IL           | Insertion Loss   |   |
| Infotainment | Information and Entertainment                            |   |
| InGaAs       | Indium Gallium Arsenide                                  | Alloy used for IR image sensors   |
| InSb         | Indium Antimonide  | Compound used for photovoltaic sensors reacting to IR light   |
| INTB         | Interrupt pin  | As used for TI SerDes chips   |
| I/O          | Input/Output   |   |
| IoT          | Internet of Things                                       |   |
| IP           | Internet Protocol  |   |
| IP Code      | Ingress Protection Code or International Protection Code | IEC (= EN) 60529 defines classes for mechanical protection for components in cars   |
| IPMI         | Intelligent Platform Management Interface                | I2C derivate  |

|       | Abbreviation  | Explanation   |
|-------|---|---|
| IPsec | Internet Protocol SECURITY  |   |
| IR    | InfraRed  | Frequency spectrum just below the visible light                                       |
| ISDB  | Integrated Services Digital Broadcasting                            | Digital television standard that originated in Japan                                  |
| ISI   | Inter Symbol Interference   |   |
| ISM   | Industrial, Science, Medical  | Identification of “open” frequency bands that may be used for these purposes          |
| ISO   | International Organization for Standardization                      | SSO seated in Geneva, Switzerland   |
| ISP   | Image Signal Processor  |   |
| IT    | Information Technology  |   |
| ITU   | International Telecommunication Union                               | SSO seated in Geneva, Switzerland   |
| IUT   | Implementation Under Test   |   |
| IVC   | In-Vehicle Communication  |   |
| IVI   | In-Vehicle Infotainment   |   |
| IVN   | In-Vehicle Network(ing)   | Physical communication network in cars, typically comprising several IVC technologies |
| JAE   | Japan Aviation Electronics industry Ltd.                            |   |
| JEIDA | Japan Electronic Industry Development Association                   | Japanese SSO, now JEITA   |
| JEITA | Japan Electronics and Information Technology industries Association | Japanese SSO  |
| JITC  | Just-In-Time-Canceller  | Retrain possibility of the A-PHY 1.0  |
| JPEG  | Joint Photographic Experts Group                                    |   |
| JTAG  | Joint Test Action Group   |   |
| JVC   | Japan Victor Company  | Originator of VHS   |
| k     | kilo  | 10 <sup>3</sup>   |
| LAN   | Local Area Network  |   |
| Laser | Light Amplification by Stimulated Emission of Radiation             |   |
| LCA   | Lane Center Assist  |   |
| LCD   | Liquid Crystal Display  |   |
| LCL   | Longitudinal Conversion Loss  |   |
| LDF   | LIN Description File  |   |
| LED   | Light Emitting Diode  |   |
| LFLT  | Line FauLT  | Pin at GSML deserializer  |
| Lidar | Llght Detection And Ranging   | Sensor type   |
| LIN   | Local Interconnect Network  |   |

|         | Abbreviation  | Explanation   |
|---------|---|---|
| LISN    | Line Impedance Stabilization Network  |   |
| LK      | Link Key  | Part of the ASA security concept  |
| LLC     | Limited Liability Company   |   |
| LNB     | Low Noise Block (converter)   | Part of satellite antenna systems to enable a low noise reception                               |
| LOMMF   | Laser Optimized MMF   |   |
| LP      | Low Power   |   |
| LPI     | Low Power Idle  | Part of EEE   |
| LRR     | Long Range Radar  |   |
| LSB     | Least Significant Bit   |   |
| LSFR    | Linear Shift Feedback Register  |   |
| LT      | Lower Tester  |   |
| LTE     | Long Term Evolution   | 4G mobile phone standard  |
| LVC MOS | Low Voltage CMOS  |   |
| LVDS    | Low Voltage Differential Signaling  | Early principle behind serialization  |
| m       | mandatory   |   |
| M       | Mega  | 10 <sup>6</sup>   |
| M2M     | Machine to Machine  |   |
| MAC     | Medium or Media Access Control  | Part of ISO/OSI DDL layer for Ethernet  |
| MASS    | MIPI Automotive SerDes Solutions  |   |
| MC      | Message Counter, MultiCast, or Mode Conversion  |   |
| MCM     | MultiChip Modules   |   |
| MCS     | Manufacturer Command Set  | Part of MIPI DSI  |
| MDC     | Management Data Clock   | Used with Ethernet PHY management   |
| MDI     | Media Dependent Interface   | Part of Ethernet physical layer definition  |
| MDIO    | Management Data Input/Output  |   |
| MEMS    | Micro Electro-Mechanical System (module)  |   |
| (x)MII  | Any type of Media Independent Interface   | Interface used between Ethernet PHYs and MAC  |
| MIMO    | Multiple Input Multiple Output  |   |
| MIPI    | Original meaning: Mobile Industry Processor Interface, however, this meaning is no longer used. | Alliance developing technical specifications in the mobile eco-system (and also the MIPI A-PHY) |
| MJPEG   | Motion Joint Photographic Experts Group   | Video and audio compression formats   |
| MM      | Machine Model   | Type of ESD test  |
| MMF     | MultiMode Fiber   | Type of GOF   |



|              | Abbreviation                                   | Explanation  |
|--------------|--|--|
| MMIC         | Monolithic Microwave Integrated Circuits       | ICs optimized for processes running between 300 MHz and 300 GHz                    |
| MOST         | Media Oriented Systems Transport               | Automotive communication system (being phased out)                                 |
| MP3          | MPEG-2 Part 3                                  | Audio compression format   |
| MPPA         | Motion Picture Association of America          |  |
| MPEG         | Moving Pictures Experts Group                  | Important group for video compression algorithms                                   |
| MPEG-LA      | MPEG Licensing Administration                  |  |
| MQS          | Micro Quadlock System                          | Connector type for UTP cables  |
| MRR          | Mid-Range Radar                                |  |
| MSB          | Most Significant Bit                           |  |
| MSE          | Mean Square Error                              |  |
| MST          | Multi-Stream                                   | DP terminology   |
| MTD          | Modular Twisted-pair Data                      | Connector type for UTP cables  |
| MTP          | Multi-stream Transport Packet                  | Part of MST/DP   |
| NACK or nACK | Not ACKnowledged                               |  |
| NBI          | Narrow Band Interference                       |  |
| NCAP         | New Car Assessment Program                     |  |
| NCF          | Node Capability File                           | Part of LIN  |
| NEXT         | Near-End CrossTalk                             |  |
| NFC          | Near Field Communication                       |  |
| NHTSA        | National Highway Traffic Safety Administration | US administration body for safety of road vehicles                                 |
| nMQS         | Nano MQS                                       | Connector type for UTP cables  |
| NRZ          | Non-Return to Zero                             | Modulation scheme with two voltage levels  |
| nt           | thermal noise                                  |  |
| NTSC         | National Television System Committee           | Analogue television standard used especially in North America and Japan            |
| NVM          | Non-Volatile Memory                            |  |
| NZ           | Neutral Zone                                   | Area in which electromagnetic interference is neutralized                          |
| o            | optional                                       |  |
| OAM          | Operation, Administration, Management channel  | Side channel available with, for example, the ASAML and IEEE 802.3ch 2020 Ethernet |
| OB           | Odd Bytes                                      | Part of MIPI A-PHY/IEEE 2977   |
| OFDM         | Orthogonal Frequency Division Multiplexing     |  |

|         | Abbreviation  | Explanation   |
|---------|---|---|
| OLED    | Organic Light-Emitting Diode                        |   |
| OPEN    | One Pair EtherNet (Alliance)                        | Alliance developing the enabling specifications for Automotive Ethernet   |
| OpenLDI | Open LVDS Display Interface                         |   |
| OSI     | Open System Interconnection                         |   |
| OTA     | Over The Air (Updates)                              |   |
| OTP     | One-Time Programmable memory                        |   |
| P       | Profile or Power                                    | MIPI A-PHY terminology  |
| P1/P2   | Profile 1/Profile 2                                 | Part of MIPI A-PHY  |
| P2P     | Point-to-Point                                      | Communication that starts and ends within one physical link.  |
| PA      | Parking Assist                                      |   |
| PAEB    | Pedestrian AEB                                      |   |
| PAL     | Phase Alternation Line or Protocol Adaptation Layer | Analogue television standard used especially in Europe and China<br>Connect between native protocols and the MIPI A-PHY |
| PAM     | Pulse Amplitude Modulation                          |   |
| PCB     | Printed Circuit Board                               |   |
| PCIe    | Peripheral Component Interconnect express           | High-speed serial computer expansion bus  |
| PCLK    | Pixel CLock   | Important in image sensors  |
| PCM     | Pulse Code Modulation                               |   |
| PCO     | Point of Control and Observation                    | Part of ISO 9646  |
| PCS     | Physical Coding Sublayer                            | Part of the physical layer  |
| PD      | Powered Device                                      | Device that receives power over the communication line  |
| P&D     | Plug & Display                                      | First VESA display connectivity standard  |
| PDU     | Protocol Data Unit                                  |   |
| PER     | Packet Error Rate                                   |   |
| PE-X    | PolyEthylene (also XPE)                             |   |
| PFC     | Priority-based Flow Control                         | Part of IEEE 802.1Qbb 2011  |
| P-frame | Predictive coded Frame or picture                   | Part of MPEG encoding   |
| PHD     | PHY Header Data                                     | Part of the IEEE 802.3cz PCS  |
| PHY     | PHYSical Layer                                      | Lowest layer (layer 1) of the ISO/OSI layering model  |
| PICS    | Protocol Implementation Conformance Statements      |   |
| PIN     | P-type – Intrinsic region – N-type                  | Diode type with larger intrinsic region   |

|         | Abbreviation   | Explanation   |
|---------|--|---|
| PLC     | Product Life Cycle or Power Line Communication         |   |
| PLL     | Phase Lock Loop  |   |
| PLS     | Physical Layer Signaling (service interface)           | Communication between reconciliation and MAC layer in IEEE 802.3 specifications                     |
| PMA     | Physical Medium Attachment                             | Part of the physical layer  |
| PMBus   | Power Management Bus                                   | I2C derivate  |
| PMD     | Physical Medium Dependent                              | Part of the physical layer (used in A-PHY or IEEE 802.3 optical Ethernet transmission technologies) |
| PoC     | Power Over Coaxial                                     |   |
| PoD     | Power Over Differential cables                         |   |
| PoDL    | Power Over Data Line                                   | Specified in IEEE 802.3bu 2016 for single pair (T1) Ethernet  |
| PoE     | Power Over Ethernet                                    | Specified in IEEE 802.3af 2003 for two pair Ethernet versions                                       |
| POF     | Polymer/Plastic Optical Fiber                          |   |
| PP      | PolyPropylene  |   |
| p-p     | Peak-to-Peak   |   |
| PPI     | Pixels Per Inch or PHY Protocol Interface              | PHY Protocol Interface is part of the MIPI C-PHY  |
| PPM     | Parts Per Million                                      |   |
| pps     | Pixels Per Second                                      |   |
| PRBS    | Pseudo-Random Bit Sequence                             |   |
| Prio    | Priority   |   |
| Pro-AV  | Professional Audio and Video                           |   |
| Prot.   | Protocol   |   |
| PS      | PolyStyrene  | Insulation material   |
| PSAACRF | Power Sum Alien Attenuation to Crosstalk Ratio Far-end |   |
| PSANEXT | Power Sum Alien Near-End crossTalk                     |   |
| PSD     | Power Spectral Density                                 |   |
| PSE     | Power Supply/Sourcing Equipment                        | Part that supplies the power in case power is supplied over the data line                           |
| PSI5    | Peripheral Sensor Interface Five                       | Low speed sensor bus  |
| PSNR    | Peak Signal-to-Noise-Ratio                             |   |
| PSR     | Panel Self Refresh                                     | Part of DP/eDP  |
| PTB     | Precision Time Base                                    | Part of the ASAML technology  |
| PVC     | PolyVinyl Chloride                                     |   |

|          | Abbreviation  | Explanation   |
|----------|---|---|
| PWM      | Pulse-Width Modulation                                | Physical principle for simple data transmission             |
| QAM      | Quadrature Amplitude Modulation                       |   |
| QFN      | Quad Flat No leads                                    | Type of semiconductor housing                               |
| QM       | Quality Management                                    | Lowest functional safety level in ISO 26262                 |
| QoS      | Quality of Service                                    |   |
| R/W      | Read/Write  |   |
| Radar    | RAdio Detection And Ranging                           |   |
| RAM      | Random Access Memory                                  |   |
| RBP      | Reverse Battery Protection                            |   |
| RBR      | Reduced Bit Rate                                      | Data rate class for DP                                      |
| RCA      | Radio Corporation of America or Reverse Channel Audio | Connector used for CVBS video or part of the HDMI interface |
| RCCB     | Red Clear Clear Blue                                  | Alternative CFA for imagers                                 |
| RCTA     | Rear Cross Traffic Alert                              |   |
| RCW      | Rear Collision Warning                                |   |
| RD       | Running Disparity                                     | Part of the 8B10B encoding scheme                           |
| RF       | Radio Frequency                                       |   |
| RFC      | Request For Comments                                  | Name for standard documents created by the IETF             |
| RFFE     | Radio Frequency Front End                             |   |
| RG       | Radio Guide   | Old nomenclature for cables                                 |
| RGB      | Red Green Blue  |   |
| RGGG     | Red Green Green Blue                                  | Name sometimes used for Bayer CFA                           |
| RJ       | Registered Jack                                       |   |
| RL       | Return Loss   |   |
| RMII     | Reduced MII   |   |
| ROM      | Read Only Memory                                      |   |
| RQ       | ReQuest   |   |
| RS-FEC   | Reed Solomon FEC                                      | Type of FEC   |
| RSE      | Rear Seat Entertainment                               |   |
| RTP      | Real-time Transport Protocol                          |   |
| RTS      | ReTranSmission  |   |
| RX or Rx | Receiver/receive                                      |   |
| SA       | Shield/Screening Attenuation                          |   |
| SAE      | Society of Automotive Engineers                       | US-based SSO  |
| SATA     | Serial Advanced Technology Attachment                 | Computer bus interface connecting computing with storage    |